

SAINT-GOBAIN BORON NITRIDE

POWDER SOLUTIONS



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Functional Fillers & Additives to Enable High **Performance Solutions in Demanding Applications**

Saint-Gobain Boron Nitride Powder Solutions merge the key properties of hexagonal boron nitride (hBN) and over 60 years of manufacturing expertise to offer a complete portfolio of hBN powders.

With a variety of engineered particle shapes and sizes available, Saint-Gobain Boron Nitride Powder Solutions enable our customers to maximize the benefits of boron nitride in a wide array of markets and applications.

OUR PARTICLE OFFERING

PLATELET PARTICLES

Average diameter from 1 to 30 µm



Due to its lamellar crystal structure, the simplest form of hBN particles are platelets. Three classes of platelet powders are included in the Saint-Gobain Boron Nitride Powder Solutions portfolio to provide a balance of form and function.

Platelets provide the best value for:

- > High shear mixing operations
- > Lubrication enhancement
- > Applications that require fine particles

ENGINEERED AGGLOMERATES

Average particle sizes from 35 to 350 µm



In many cases, the high aspect ratio and surface area of BN platelets can pose processing challenges. Our Spherical Agglomerates can help overcome these challenges in certain applications. Agglomerates with tailored sizes, shapes or other properties can be discussed upon request.

Benefits include:

- More isotropic thermal properties
- > Improved flowability for easy handling
- > Enhanced particle packing

Thermal Conductivity

thru-plane in-plane

Dielectric Strength

80 kV/mm

Dielectric Constant

Coefficient of Friction

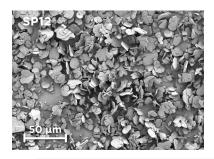
< 0.3

Mohs Hardness

1.5

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Powder Class Descriptions



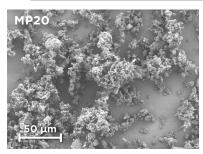
Powder Class

Standard Platelets

Standard Platelets powders are high purity single crystals of BN with no agglomeration and tight size distribution around the D50.

Applications

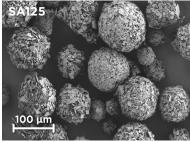
- > Dielectric thermal filler
- > Potting compound
- > Polymer processing aid
- > Lubricant additive
- > Mold release
- > Nucleation aid
- > Cosmetic formulations



Modified Platelets

MP20 and MP50 are made of submicron BN crystals with different oxygen levels. MP05 is a higher density, slightly agglomerated particle of high purity platelets.

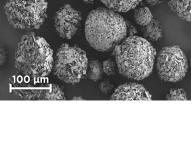
- > Powder metal additive
- > Polymer processing aid
- > Lubricant additive

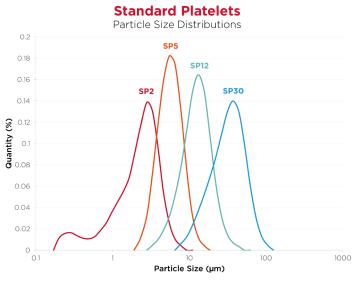


Spherical Agglomerates

Agglomerate powders with tight size distributions and spherical morphology for excellent packing and flowability. Provides higher through-plane thermal conductivity than platelet powders.

- > High performance dielectric thermal filler
- > Potting compound filler
- > Thermal spray powder feed





Spherical Agglomerates Particle Size Distributions 0.35 SA125 SA300 Quantity (%) 0.2 0.15 0.1 1000

Particle Size (µm)



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Typical Powder Properties

	d10	d50	d90	Tap Density	Surface Area	BN Content	B ₂ O ₃	O ₂
	μm	μm	μm	g/cm³	m²/g	%	%	%
Standard Platelets								
SP2	0.6	2.2	4.2	0.20	12	98.6	0.06	1.3
SP5	3.3	5.5	10	0.30	9.0	99.3	0.10	0.6
SP6	3.9	6.5	12	0.45	8.0	99.6	0.04	0.4
SP8	4.2	8.5	19	0.45	2.8	99.3	0.02	0.7
SP12	6.0	12	23	0.50	1.8	99.3	0.02	0.7
SP16	7.4	16	29	0.50	1.6	99.4	0.02	0.6
SP30	14	30	50	0.55	1.1	99.7	0.02	0.3
Modified Plate	elets	,					,	
MP50	0.6	3.3	20	0.60	40	95.0	0.90	4.8
MP20	1.0	5.4	20	0.55	40	98.0	0.40	1.7
MP05	4.4	10	20	0.65	15	99.2	0.30	0.7
Spherical Agg	lomerates	S						
SA35	20	35	55	0.50	4.2	99.5	0.03	0.3
SA75	55	75	105	0.50	4.0	99.5	0.03	0.3
SA125	95	130	185	0.45	3.9	99.5	0.03	0.3
SA300	200	315	500	0.40	2.8	99.5	0.02	0.3

Typical properties, not to be used as product specification. We specialize in customizing our powder solutions to address customer needs. Custom offerings can be discussed upon request.



Saint-Gobain Boron Nitride

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